

Revision History - AS7C164A

Revision	Details	Date
Rev 1.0	Preliminary datasheet	November 2009
Rev 2	Added 28pin Skinny PDIP(300mil) package option	May 2015

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FEATURES

- Fast access time : 12/15 ns
- Low power consumption: Operating current : 110/100/90/80mA (TYP.) Standby current : 1mA (TYP.)
- Single 5V power supply
- All inputs and outputs TTL compatible
- Fully static operation
- Tri-state output
- Data retention voltage : 2.0V (MIN.)
- Green package available
- Package : 28-pin 300 mil SOJ 28-pin 300 mil Skinny P-DIP

GENERAL DESCRIPTION

The AS7C164A is a 65,536-bit high speed CMOS static random access memory organized as 8,192 words by 8 bits. It is fabricated using very high performance, high reliability CMOS technology. Its standby current is stable within the range of operating temperature.

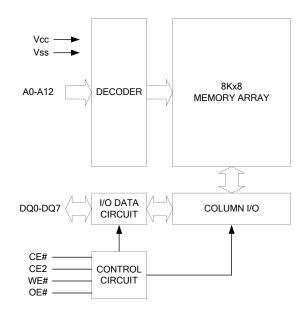
The AS7C164A is well designed for high speed system applications, and particularly well suited for battery back-up nonvolatile memory application.

The AS7C164A operates from a single power supply of 5V and all inputs and outputs are fully TTL compatible

PRODUCT FAMILY

Product	Operating	Vcc Range	Speed	Power D	Dissipation
Family	Temperature	VCC Range	Speed	Standby(IsB1,TYP.)	Operating(Icc,TYP.)
AS7C164A	0 ~ 70°C	4.5 ~ 5.5V	12/15ns	1mA	110/100/90/80mA

FUNCTIONAL BLOCK DIAGRAM

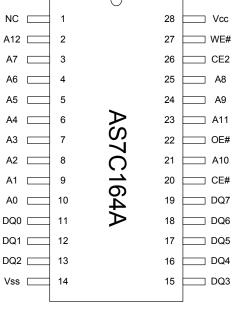


PIN DESCRIPTION

SYMBOL	DESCRIPTION
A0 - A12	Address Inputs
DQ0 – DQ7	Data Inputs/Outputs
CE#, CE2	Chip Enable Inputs
WE#	Write Enable Input
OE#	Output Enable Input
Vcc	Power Supply
Vss	Ground
NC	No Connection



PIN CONFIGURATION



Skinny PDIP/SOJ

ABSOLUTE MAXIMUM RATINGS*

PARAMETER	SYMBOL	RATING	UNIT
Voltage on Vcc relative to Vss	VT1	-0.5 to 6.5	V
Voltage on any other pin relative to Vss	VT2	-0.5 to Vcc+0.5	V
Operating Temperature	TA	0 to 70(C grade)	°C
Storage Temperature	Tstg	-65 to 150	°C
Power Dissipation	PD	1	W
DC Output Current	Ιουτ	50	mA

*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to the absolute maximum rating conditions for extended period may affect device reliability.

TRUTH TABLE

MODE	CE#	CE2	OE#	WE#	I/O OPERATION	SUPPLY CURRENT
Standby	Н	Х	Х	Х	High-Z	I _{SB1}
Standby	Х	L	Х	Х	High-Z	ISB1
Output Disable	L	Н	Н	Н	High-Z	lcc
Read	L	Н	L	Н	Dout	lcc
Write	L	Н	Х	L	DIN	lcc

Note: $H = V_{IH}$, $L = V_{IL}$, X = Don't care.



DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION		MIN.	TYP. [™]	MAX.	UNIT
Supply Voltage	Vcc			4.5	5.0	5.5	V
Input High Voltage	VIH ^{*1}			2.4	-	Vcc+0.5	V
Input Low Voltage	VIL ^{*2}			- 0.5	-	0.8	V
Input Leakage Current	Iц	$V_CC \geqq V_IN \geqq V_SS$		- 1	-	1	μA
Output Leakage Current	Ilo	$Vcc \ge Vout \ge Vss$, Output Disabled		- 1	-	1	μA
Output High Voltage	Vон	Іон = -1mA		2.4	-	-	V
Output Low Voltage	Vol	IoL = 2mA		-	-	0.4	V
Average Operating Power supply Current	lcc	Cycle time = Min. CE# = Vi∟ and CE2 = Viн, Ii/o = 0mA Other pins at Viн or Vi∟	-12 -15	-	90 80	160 140	mA mA
Standby Power Supply Current	ISB1	CE# \geq V _{CC} -0.2V or CE2 \leq Other pins at 0.2V or V _{CC} -		-	1	5	mA

Notes:

1. $V_{IH}(max) = V_{CC} + 3.0V$ for pulse width less than 10ns.

2. $V_{IL}(min) = V_{SS} - 3.0V$ for pulse width less than 10ns.

3. Over/Undershoot specifications are characterized, not 100% tested.

4. Typical values are included for reference only and are not guaranteed or tested. Typical valued are measured at V_{CC} = V_{CC}(TYP.) and T_A = 25° C

CAPACITANCE (TA = 25°C, f = 1.0MHz)

PARAMETER	SYMBOL	MIN.	MAX	UNIT
Input Capacitance	Cin	-	6	pF
Input/Output Capacitance	Cı/o	-	8	pF

Note : These parameters are guaranteed by device characterization, but not production tested.

AC TEST CONDITIONS

Input Pulse Levels	0.2V to Vcc - 0.2V
Input Rise and Fall Times	3ns
Input and Output Timing Reference Levels	1.5V
Output Load	Сь = 30pF + 1TTL, Іон/Іоь = -4mA/8mA



AC ELECTRICAL CHARACTERISTICS

(1) READ CYCLE

PARAMETER	SYM.	AS7C1	64A-12	AS7C1	64A-15	UNIT
		MIN.	MAX.	MIN.	MAX.	
Read Cycle Time	trc	12	-	15	-	ns
Address Access Time	taa	-	12	-	15	ns
Chip Enable Access Time	t ACE	-	12	-	15	ns
Output Enable Access Time	toe	-	6	-	7	ns
Chip Enable to Output in Low-Z	tc∟z*	3	-	4	-	ns
Output Enable to Output in Low-Z	tolz*	0	-	0	-	ns
Chip Disable to Output in High-Z	tснz*	-	6	-	7	ns
Output Disable to Output in High-Z	tонz*	-	6	-	7	ns
Output Hold from Address Change	tон	3	-	3	-	ns

(2) WRITE CYCLE

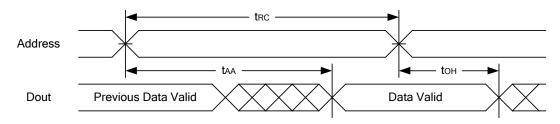
PARAMETER	SYM.	AS7C164A-12 AS		AS7C1	64A-15	UNIT
		MIN.	MAX.		MAX.	
Write Cycle Time	twc	12	-	15	-	ns
Address Valid to End of Write	taw	10	-	12	-	ns
Chip Enable to End of Write	tcw	10	-	12	-	ns
Address Set-up Time	tas	0	-	0	-	ns
Write Pulse Width	twp	9	-	10	-	ns
Write Recovery Time	twr	0	-	0	-	ns
Data to Write Time Overlap	tow	7	-	8	-	ns
Data Hold from End of Write Time	tон	0	-	0	-	ns
Output Active from End of Write	tow*	3	-	4	-	ns
Write to Output in High-Z	twнz*	-	7	-	8	ns

*These parameters are guaranteed by device characterization, but not production tested.

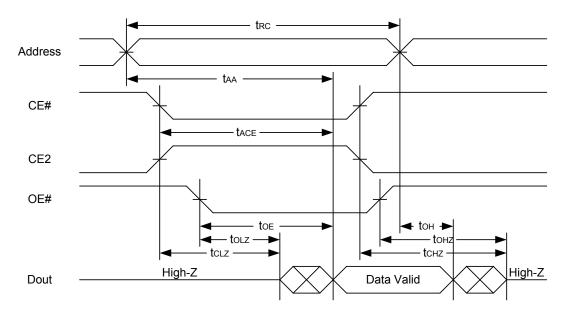


TIMING WAVEFORMS

READ CYCLE 1 (Address Controlled) (1,2)



READ CYCLE 2 (CE# and CE2 and OE# Controlled) (1,3,4,5)



Notes :

1.WE# is high for read cycle.

2.Device is continuously selected OE# = low, CE# = low., CE2 = high.

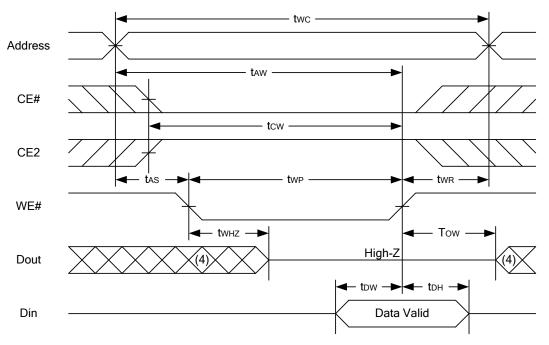
3.Address must be valid prior to or coincident with CE# = low, CE2 = high; otherwise tAA is the limiting parameter.

 $4.t_{CLZ}$, t_{CLZ} , t_{CHZ} and t_{OHZ} are specified with C_L = 5pF. Transition is measured ±500mV from steady state.

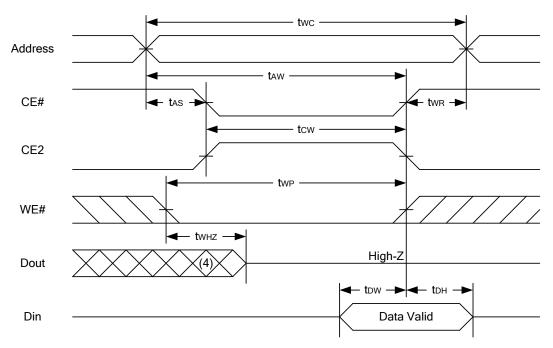
5.At any given temperature and voltage condition, t_{CHZ} is less than t_{CLZ} , t_{OHZ} is less than t_{OLZ} .



WRITE CYCLE 1 (WE# Controlled) (1,2,3,5,6)



WRITE CYCLE 2 (CE# and CE2 Controlled) (1,2,5,6)



Notes :

- 2.A write occurs during the overlap of a low CE#, high CE2, low WE#.
- 3.During a WE#controlled write cycle with OE# low, twp must be greater than twHz + tow to allow the drivers to turn off and data to be placed on the bus.
- 4. During this period, I/O pins are in the output state, and input signals must not be applied.
- 5.If the CE#low transition and CE2 high transition occurs simultaneously with or after WE# low transition, the outputs remain in a high impedance state.
- 6.tow and t_{WHZ} are specified with C_L = 5pF. Transition is measured ±500mV from steady state.

^{1.}WE#, CE# must be high or CE2 must be low during all address transitions.



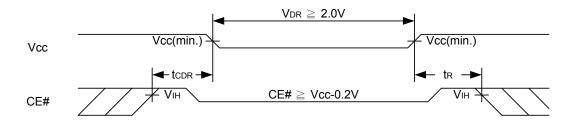
DATA RETENTION CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Vcc for Data Retention		$\begin{array}{l} \text{CE\#} \geqq V_{\text{CC}} \text{-} 0.2 \text{V} \\ \text{or CE2} \leqq 0.2 \text{V} \end{array}$	2.0	-	5.5	V
Data Retention Current		$\begin{array}{l} \mbox{Vcc} = 2.0\mbox{V} \\ \mbox{CE\#} \geq \mbox{Vcc} - 0.2\mbox{V} \mbox{ or } \mbox{CE2} \leq 0.2\mbox{V} \\ \mbox{Others at } 0.2\mbox{V} \mbox{ or } \mbox{V}_{\mbox{cc}} - 0.2\mbox{V} \end{array}$	-	0.6	3	mA
Chip Disable to Data Retention Time	tcdr	See Data Retention Waveforms (below)	0	-	-	ns
Recovery Time	tR		tRC∗	-	-	ns

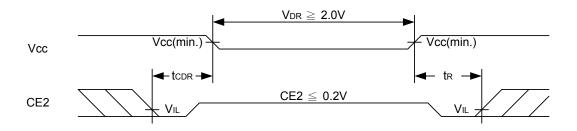
tRC∗ = Read Cycle Time

DATA RETENTION WAVEFORM

Low Vcc Data Retention Waveform (1) (CE# controlled)



Low Vcc Data Retention Waveform (2) (CE2 controlled)

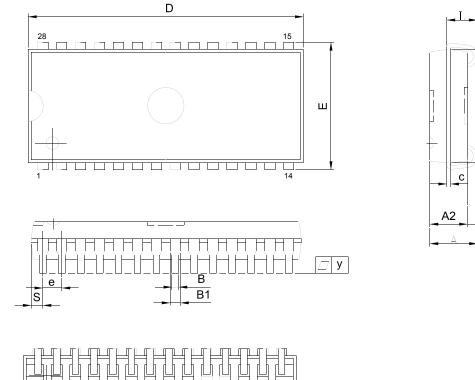


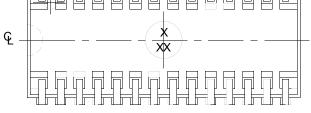


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A1

28-pin 300 mil SOJ Package Outline Dimension





UNIT SYM.	INCH(REF)	MM(BASE)
A	0.140 (MAX)	3.556 (MAX)
A1	0.026 (MIN)	0.660 (MIN)
A2	0.100±0.005	2.540±0.127
В	0.018±0.003	0.457±0.076
B1	0.028 ±0.003	0.711±0.076
С	0.010±0.003	0.254±0.076
D	0.710±0.010	18.03±0.254
E	0.337±0.010	8.560±0.254
E1	0.300±0.005	7.620±0.127
е	0.050±0.003	1.270±0.076
L	0.087±0.010	2.210±0.254
S	0.030±0.004	0.762±0.102
Y	0.003 (MAX)	0.076 (MAX)

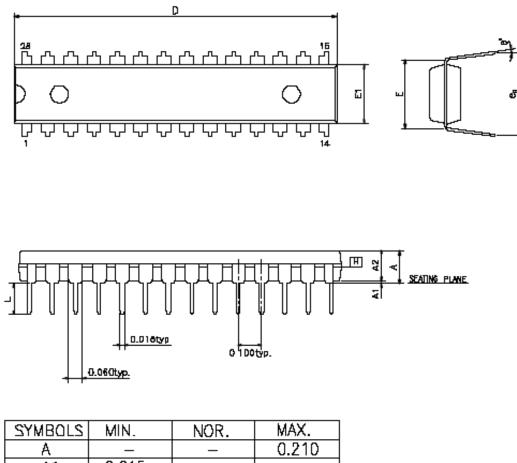
Note : 1.S/E/D dimension is not including mold flash.

2. The end flash in package lengthwise is not more than 10 mils each side.



PACKAGE OUTLINE DIMENSION

28 pin 300 mil PDIP Package Outline Dimension



	IVITIN.	NON.	191774		
A	—	—	0.210		
A1	0.015	—	—		
A2	D.125	0.130	0.135		
D	1.385	1.390	1.400		
E	0.310 BSC				
E1	0.283	0.288	0.293		
L	0.115	0.130	0.150		
ĈB	0.330	0.350	0.370		
Ð	0	7	15		
UNIT : INCH					

NOTE: 1.JEDEC OUTLINE : MS-D15 AH



ORDERING INFORMATION

Package/Access Time	Temperature	12 ns	15 ns
28-pin 300 mil SOJ	Commercial	AS7C164A-12JCN	AS7C164A-15JCN
28-pin 300 mil Skinny P-DIP	Commercial		AS7C164A-15PCN
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Suffix TR = tape and reel

PART NUMBERING SYSTEM

AS7C		164A	-XX	J/P	C/I	N
SRAM prefix	Voltage: 5V supply	Device Number	Access Time	J = SOJ, 300 mil P= Skinny P-DIP, 300 mil	Temperature Range: C = 0° ~ 70 °C I = -40° ~ 85° C	N = Lead Free Part





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